

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Akihiko ENDO et al. Group Art Unit : 2812
Appl. No. : 10/569,942 Examiner : Seahvosh J NIKMANESH
Filed : February 28, 2006 Confirmation No. : 1077
For : METHOD FOR MANUFACTURING BONDED WAFER

SUPPLEMENTAL AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop AMENDMENT
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir :

The present Amendment is supplemental to the Amendment filed November 7, 2008. Inasmuch as the Amendment of November 7, 2008 is fully responsive to the Office Action mailed August 7, 2008, and the three-month shortened statutory period was set in the Office Action to expire on November 7, 2008, no fee for extension of time is believed necessary. However, should any extension of time fees or other fees be required to maintain pendency of the application, however, authorization is hereby provided to charge any fees to Deposit Account No. 19-0089.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 4 of this paper.